

Metal-Organic Framework Nanofilm for Mechanically Flexible Information Storage Applications

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Abstract

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Full Text

Preamble

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Metal-organic frameworks (MOFs), which are formed by association of metal cations or clusters of cations (“nodes”) with soft organic bridging ligands (“linkers”), are a fascinating class of flexible crystalline hybrid materials offering potential strategy for the construction of flexible electronics. In this study, a high-quality MOF nanofilm, HKUST-1, on flexible gold-coated polyethylene terephthalate substrates is fabricated using liquid phase epitaxy approach. Uniform and reproducible resistive switching effect, which can be sustained under the strain of as high as 2.8%, and over the wide temperature range of -70 to +70 °C, is observed for the first time in the all solid-state Au/HKUST-1/Au thin film structures. Through conductive atomic force microscopic and depth-profiling X-ray photoelectron spectroscopic analysis, it is proposed that the electric field-induced migration of the Cu²⁺ ions, which may lead to subsequent pyrolysis of the trimesic acid linkers and thus the formation of highly conducting filaments, could be the possible origin for the observed uniform resistance switching in HKUST-1 nanofilms.

1. Introduction

The ever-increasing concerns about the monitoring of human health have greatly inspired the recent development of wearable electronic equipment, including epidermal electrode arrays, tactile sensors, bendable displays, etc., [1-6] the most fundamental features of which are mechanical flexibility and environmental stability. Being fabricated on soft substrates or even used as free-standing films, [7] flexible electronics are required to be lighter, more conformal, more portable, and less expensive for manufacturing, in comparison with their rigid counterparts. As an integrated component of any digital gadget, information storage chips should also be made flexible for wearable applications. [8-11] In view of this, the recently developed resistance random access memories (RRAMs), which received tremendous attention as an alternative to charge-based memories such as dynamic random access memory and flash memory, have distinguished themselves as promising candidates for flexible and consumer electronic applications, with the advantages of simple structure, easy fabrication process, and low-cost potential. [12-15]

However, there still exist scientific and technical challenges at the moment that impede flexible resistive memories from practical applications. For instance, brittle inorganic materials-based memories, which usually demonstrate reliable storage performance on rigid substrates, suffer severely from limited adaptivity to large strains upon repeated bending or stretching operations. [16,17] On the contrary, though soft organic electronic materials carry inherent mechanical flexibility, their poor resistance to changing environments makes them improper for working under harsh conditions. [18,19] Moreover, memory devices should remain stable and reliable under various deformation scenarios to avoid any possible misoperation on stored data. Thus, more efforts should be devoted by material scientists toward designing novel materials with new functionalities.

With these concerns, metal-organic frameworks (MOFs), which can be taken as rigid metal oxide matrix extended by soft organic linkers and possess features of both inorganic and organic materials, [21-23] may provide alternative strategy for the construction of flexible resistive memories. Very recently, it is documented that the conductivity states of a metal/macroscopic MOF single crystal/metal structure can be tuned bistably by the self-limiting oxidative reaction of the metal anode involving liquid species. [24] We also observed stable and low-power resistance switching effect in MOF single crystals, which is probably related to the ferroelectric transition of $N \cdots H-O \cdots H-N$ bridge-structured dipoles of guest water molecules inside the MOF nanochannels. [25] Nevertheless, it is still challenging at the moment to construct a liquid-free and flexible MOF thin film for practical wearable information storage applications.

Inspired by these, we herein report the direct deposition of a high-quality MOF nanofilm, HKUST-1, on flexible gold-coated polyethylene terephthalate (PET) substrates, and its promising memory performance. Uniform and reproducible resistive switching effect, which can be sustained under strain as high as 2.8%,

and over the wide temperature range of -70 to $+70$ °C, has been observed for the first time in all solid-state Au/HKUST-1/Au thin film structures. The mechanical flexibility and environmental stability well meet requirements for wearable application under earth surface conditions. Through conductive atomic force microscopic (C-AFM) and depth-profiling X-ray photoelectron spectroscopic (XPS) analysis, we propose that the electric field-induced migration of the Cu^{2+} ions, which may lead to subsequent pyrolysis of the trimesic acid linkers and thus formation of highly conducting filaments, could be the possible origin for the observed uniform resistance switching in HKUST-1 nanofilms. With the intrinsic properties of the MOF material, namely the 3D periodical nature of the framework and the synergistic interplay between the metal species and organic linkers, to produce the resistive switching effect, the mechanically flexible HKUST-1 nanofilm may provide a more appropriate and controllable platform for the construction of wearable information storage devices.

2. Results and Discussion

HKUST-1 (Cu (BTC) , BTC = benzene-1,3,5-tricarboxylic acid), which is assembled from binuclear Cu(II) paddlewheel and tridentate trimesate molecules, is a widely explored MOF material with well-defined 3D framework structure (Figure S1a, Supporting Information). [26-28] The growth mechanism of HKUST-1 has been well understood over the past decade and thus renders the possibility of preparing high-quality MOF nanofilms. [29-31] In this work, the HKUST-1 nanofilms were prepared on gold/PET flexible substrates through a modified liquid phase epitaxy approach (LPE). [32-34] The entire process was done automatically in a home-designed apparatus (Figure 1[Figure 1: see original paper]a) to avoid exposure to the atmosphere and eliminate any possible contamination from air. In order to obtain a high-quality continuous MOF nanofilm with good resistive switching behavior and mechanical flexibility, a typical film thickness of 130 nm, with grain size of 40 to 80 nm and promising morphological uniformity with rms roughness of 4 nm, was selected when fabricating the HKUST-1 samples in the present study (Figures 1b and S1b, S1c, Supporting Information).

The HKUST-1 nanofilm demonstrates good bendability on the flexible Au/PET substrate (Figure 1c). X-ray diffraction pattern, Fourier transformed infrared spectrum and Raman spectrum (Figure S1d-S1f, Supporting Information) suggest that the as-deposited HKUST-1 films have a (111) direction-oriented polycrystalline structure, which is in good agreement with that reported in the literature. [26,33,35]

The room-temperature bipolar resistive switching behavior of the Au/HKUST-1/Au/PET sandwich structures is shown in the current-voltage (I-V) characteristics of Figure 2[Figure 2: see original paper]a. The virgin devices are always in high resistance state (HRS, or OFF state) with a resistance of 10^{13} - 10^{12} Ω . A positive voltage of around 15 V has been first applied to the bottom electrode with a compliance current (I_{cc}) of 0.01 A to initialize the device to a low

resistance state (LRS, or ON state), which serves as the “forming” process in memory devices (Inset of Figure 2a). The device stayed at ON state when the power is turned off or during the following positive voltage sweeps, indicating the nonvolatile characteristic of the resistive switching of Au/HKUST-1/Au/PET device. A reverse sweeping voltage of -0.53 V can recover the high resistance state, and this negatively-biased sweeping serves as the “reset” or “erase” process of a rewritable device. In the following positive sweeps, a much smaller set voltage of 0.78 V is sufficient to switch the device to the ON state again, thus completing the “write-read-erase-read-rewrite” cycle of a rewritable memory. Though the ON/OFF ratio of the present device (e.g., 18.5, read at 0.1 V) is not as large as those reported in the literature, [13] it is still sufficient for today’s state-of-the-art CMOS circuits to differentiate the programmed resistance states. [14]

The memory performance of the Au/HKUST-1/Au/PET device, which has an original length of 13 mm at the flat state, gets well retained during dynamic and static bending tests. The bended surface of the device is assumed as an ideal part of a perfect circle at all bending radii, [7,36] while slight deviation from perfection may lead to some acceptable error for bending radius estimation (Figure S2, Supporting Information). As shown in Figure 2b, the resistive switching behavior of the device is insensitive to the bending rates. When the bending rates increase from 0.25 to 2 mm s⁻¹, the I-V response remains almost unchanged. Herein, the bending rate is defined as the rate at which the direct distance between the two sides of the device is decreased, while in all batches of the dynamic bending tests, the final bending radii are kept constant at 3.4 mm. Moreover, when the strain of the device increases from 0.93% to 2.8% (or, the bending radius decreases from 9.6 to 3.2 mm), only a minor decrease of the ON/OFF ratio or slight fluctuation in the switching voltages of the device is observed (Figure 2c,d). To be more representative, the resistive switching has been cycled for over 30 times at each bending radius or strain level to increase the sample capacity. The strain level of 2.8% , at which the HKUST-1 memory can still work normally, is superior to that of most inorganic counterparts. [17] When the surface strain of the device exceeds 2.8% (with the bending radius being less than 3.2 mm), the resistive switching effect vanishes and the device becomes highly conductive (Figure S3a, Supporting Information). Optical microscope image reveals that the appearance of cracks throughout the HKUST-1 thin film may be responsible for the failure of the MOF devices (Figure S3b, Supporting Information). When the MOF nanofilms are deposited on even softer poly(dimethylsiloxane) (PDMS) substrates or used as free-standing functional layers, the flexibility of the memory device may be further extended from being only bendable to stretchable and twistable for real wearable application under various deformation conditions. Currently, we are capable of peeling the HKUST-1 nanofilm off from the substrate, but attaching electrodes on both sides of the free-standing nanofilm, or directly depositing the MOF film on PDMS substrate, is still problematic at the moment.

Cyclic switching operations were also conducted to further investigate the uni-

formity of the resistance switching effect at certain strain levels. To be more representative, over 50 samples have been fabricated and tested. They all exhibit similar electrical performance. As shown in Figure 3[Figure 3: see original paper]a, the resistance switching behavior can be reproduced in the Au/HKUST-1/Au/PET flexible devices for more than 300 consecutive cycles with good accuracy at the strain level of about 2.0%. The switching parameters of the HKUST-1 device are uniform, with the R_{HRS} (HRS resistance, $534 \pm 28.3 \Omega$), R_{LRS} (LRS resistance, $32 \pm 4.7 \Omega$), V_{set} (set voltage, $0.76 \pm 0.023 \text{ V}$) and V_{reset} (reset voltage, $-0.48 \pm 0.017 \text{ V}$) all distributed in a very narrow range (Figure 3b). [19] Moreover, no significant changes of the HRS/LRS resistances or the set/reset voltages have been observed when the device was bended for up to 160 times (Figure 3c,d), again suggesting device stability against mechanical stress and strain. In comparison with that at the flat state, both the HRS and LRS resistances of the memory device can be retained equally well at the strain level of 2.0% for more than 10 s (Figure 3e). Pulse-mode test suggests that the memory performance of the HKUST-1 device can even be maintained at the strain level of 2.0% for more than 10 cycles (Figure 3f).

On the earth surface, the temperature range in which human beings can survive usually varies from $-70 \text{ }^\circ\text{C}$ at the South or North Pole to $+70 \text{ }^\circ\text{C}$ at the Sahara desert. Thus, the thermal stability of the present HKUST-1 flexible memory cell was also evaluated in the same temperature region for wearable applications. For the heating and cooling treatment, the device was fixed with double-side tapes onto a convex mould with the strain of 2.0% and then mounted into the vacuum chamber of the probe station. The sample temperature was first cooling down to $-70 \text{ }^\circ\text{C}$ and raised at a ramping step of $10 \text{ }^\circ\text{C}$ until reaching $+70 \text{ }^\circ\text{C}$. At each sampling temperature, the resistive switching operation has been cycled for more than 50 times. As shown in Figure 4[Figure 4: see original paper]a, the switching between the ON and OFF states is highly reproducible in the working temperature range of -70 to $+70 \text{ }^\circ\text{C}$, which is rarely observed in organic materials-based flexible RRAM devices. The I-V characteristics remain stable and smooth when the sampling temperature varies, except for the reduced set and reset voltages (Figure 4b), which suggest that the writing and erasing processes are thermally-activated. Though the HRS and LRS resistances also decrease slightly as the sampling temperature increases, the $R_{\text{off}}/R_{\text{on}}$ ratio is still sufficient to identify the two states without severe misreading issue (Figure 4c).

C-AFM has also been employed to study the resistance switching behavior of HKUST-1 at the nanometer scale. The device structure for C-AFM measurement consists of a HKUST-1 nanofilm sandwiched between a Pt/Ir-coated conductive tip (grounded) and the Pt/SiO₂ substrate (to avoid asymmetric electrode, inset of Figure 5[Figure 5: see original paper]a). Under a low biased voltage of less than 0.5 V, the C-AFM current map of the nanofilm does not exhibit any difference in the scanning area of $3 \times 3 \mu\text{m}^2$, suggesting that the initial resistance state (IRS) of HKUST-1 has poor conductivity (Figure 5a). After applying a biased voltage of 2 V and monitoring the current response at

0.5 V, several bright spots associated with localized conductive regions have appeared (Figure 5b). These bright regions are about 10 nm in diameter. Once a biased voltage of -2 V has been applied onto the same area, these bright spots disappear correspondingly, thus mimicking the write-read-erase cycles of the macroscopic metal/HKUST-1/metal devices. The I-V characteristic of each conductive spot is similar to that of the macroscopic devices (inset of Figure 5b), therefore indicating that the resistance switching in HKUST-1 nanofilms has a filamentary nature. [37-40] Interestingly, a zoomed-in C-AFM image reveals that the resistance switching occurs inside the nanograins of the HKUST-1 thin film (Figure 5c,d).

Generally, HKUST-1 is formed from Cu^{2+} dimer and benzene-1,3,5-tricarboxylic acid (BTC) linkers. The presence of carboxylate oxygen atoms glues the metal ions and organic linkers through σ bonds, while preventing effective overlap of the d orbit in the linkers with the metal d orbit. [31,41,42] Therefore, less efficient charge carrier hopping between either the Cu^{2+} ions or the BTC linkers leads to the initial high resistance state in the nanofilm. [43-46] With the binding energy of 372 kJ mol^{-1} for two Cu-O bonds in HKUST-1, [47] the complexing between the Cu^{2+} dimer and the BTC linkers is relatively weak, as compared with that of metal-oxygen covalent bonds in oxide materials, [48] and could be disturbed by external means. Thus, copper ions in HKUST-1 nanofilm have a high probability to migrate under stimulation of high electric field. To verify this hypothesis, XPS depth-profiling analysis of the Au/HKUST-1/Au cells has been performed in their respective IRS and LRS to plot the distribution of copper species. The locations of the Au top electrode/HKUST-1 and HKUST-1/Au bottom electrode interfaces can be exactly identified in the IRS. Before application of external electric fields, the top electrode layer should not contain any copper content, while the HKUST-1 layer close to the bottom electrode should not contain any gold content either. A clear and sharp interface at the Au top electrode/HKUST-1 or the HKUST-1/Au bottom electrode is observed in Figure 6 [Figure 6: see original paper]. When the device has been switched to the LRS, copper content can be detected in the Au top electrode layer (highlighted with blue circle in Figures 6c and S4, Supporting Information), confirming that the Cu^{2+} ions (peak at 933.6 eV) have been driven into the top electrode and reduced to metallic species (Cu peak at 932.7 eV). Considering the fact that conductivity changes significantly under external electric field inside the nanograins, diffusion of Cu^{2+} ions probably also occurs inside the nanograin of the HKUST-1 films.

Based on the XPS results, a phenomenological model of the resistance switching is proposed and schematically illustrated in Figure 6c. With high electric field applied onto the Au/HKUST-1/Au sandwiched structure, Cu^{2+} ions at localized crystalline defects can be dislocated from the BTC linkers, driven into the top Au layer and reduced to Cu atoms. The negatively charged vacancies in the HKUST-1 nanofilms are relatively less stable, and the carboxylic groups can be removed from the aromatic linkers upon Joule heating and emitted as carbon dioxide through the top electrodes. [49,50] The pyrolysis of the trimesate linkers then may result in coupling of neighboring benzene rings and subsequent for-

mation of sp^2 -hybridized carbon-rich channels. [51,52] Charge carrier transport through such localized conjugated system would be more efficient as compared with hopping between either the Cu^{2+} ions or the BTC linkers, which in turn gives rise to device transition from the high resistance state to the LRS. [53] Reversed voltage can disrupt the as-formed aromatic conducting filament and reset the device to the high resistance state. As stated above, both the HRS and LRS resistances show negative dependence on sampling temperature (Figure 4c), which is in good agreement with the semiconducting nature of the OFF state charge carrier hopping process and transport through the sp^2 -hybridized conjugated system in the ON state HKUST-1 nanofilms. We are also making efforts to physically identify the molecular structure changes after the initial forming state and to verify the proposed resistive switching mechanisms. Nevertheless, with the significant difference between the driving force for breaking Cu-O bonds in HKUST-1 and subsequent migration of the Cu^{2+} ions, and that for rupture and regeneration of the sp^2 -hybridized conducting channels, obvious variation in the forming and setting/resetting voltages can be understood.

3. Conclusion

In summary, high-quality HKUST-1 nanofilms have been fabricated directly on flexible substrates using a modified LPE approach, which exhibit uniform and reproducible resistive switching effect under strain as high as 2.8%, and over the wide temperature range of -70 to $+70$ °C. Very recently, molecular ferroelectric and dielectric materials have also been demonstrated with good electrical bistability for information storage applications. [54-56] Combining the mechanical flexibility of organic materials and environmental stability of inorganic species, the ferroelectricity or dielectricity of the storage medium, as well as improvements in our understanding and control of how they transport ions and charges, metal-organic framework nanofilms are demonstrating great potential as information storage medium in future wearable electronic devices.

4. Experimental Section

Preparation of the Au/PET flexible substrates: Au/PET substrates were prepared by sputtering a 5-nm buffer layer of titanium (99.8%) and subsequently a 100-nm layer of gold (99.999%) onto prepolished PET flexible substrates at room temperature, in an E-beam evaporation chamber at a base pressure of about 10 Pa.

Preparation of the Au-OH flexible substrates: The as-prepared Au/PET flexible substrates were placed in piranha solution ($H_2SO_4:H_2O_2 = 4:1$) for 30 s and rinsed with excess amount of pure water to receive the Au-OH flexible substrates.

Deposition of the HKUST-1 nanofilms on Au-OH/PET substrate: The Au-OH substrate, placed in a home-designed reactor and sealed with a rubber stopper, was first immersed in a 50×10^{-3} M ethanol solution of $Cu(CH_3COO)_2$

(injected through a syringe and peristaltic pump as shown in Figure 1) for 10 min. After removing the solution, the substrate was then soaked with excess amount of ethanol for 5 min to remove unreacted $\text{Cu}(\text{CHCOO})$, and blow-dried in the reactor with a nitrogen stream. Subsequently, the substrate was immersed in a 20×10^{-3} M ethanol solution of BTC (benzene-1,3,5-tricarboxylic acid) for 10 min. Then, the substrate was washed again with ethanol for 5 min, and blow-dried with the nitrogen stream. The same procedure was repeated for 100 times to grow 100 layers of Cu (BTC) on the substrates. The entire preparation process was performed automatically in the home-designed apparatus as shown in the right panel of Figure 1, in order to avoid exposing the reaction environment to ambient atmosphere, which may introduce contamination onto the samples. 80-nm-thick top Au electrodes with a diameter of 100 μm were obtained by sputtering the Au target in pure argon atmosphere, using a magnetron sputter and a metal shadow mask. The total thickness of the sample can also be controlled by adjusting the total number of assembly cycles.

Characterization: The crystalline structure of the as-grown HKUST-1 nanofilms was investigated by glancing-incidence X-ray diffraction technique (GIXRD, Bruker AXS, D8 Discover) using Cu-K radiation. The incidence angle of the X-ray beam was fixed at 1° and the diffractive patterns were recorded with a step of 0.05° in the range of 5° - 20° . The thickness of the films was determined using field-emission scanning electron microscopy (FESEM, Hitachi, S-4800) with 15 kV accelerating voltage. The current-voltage (I-V) characteristics of the Au/HKUST-1/Au structure were measured on a Lakeshore probe station equipped with a precision semiconductor parameter analyzer (Keithley 4200) in dc sweep or pulse mode. The temperature dependent I-V curves of the Au/HKUST-1/Au devices were investigated in vacuum. Scanning probe microscopy (Veeco, Dimension 3100V) equipped with a conducting cantilever coated with Pt/Ir was employed for C-AFM measurements of the HKUST-1/Pt structures. Depth-profiling analysis of the elemental distribution in the Au/HKUST-1/Au structure was performed using ion-etching treatment during X-ray photoelectron spectroscopic (XPS, SHIMADZU, AXIS ULTRA DLD) measurements. A monochromatic Al-K X-ray source (1486.6 eV photons) was used at a constant dwell time of 100 ms. A pass energy of 80 or 40 eV was employed for the wide and core-level spectra scans, respectively. The X-ray source was run at a reduced power of 150 W (15 kV and 10 mA). The pressure in the analysis chamber was maintained at 10 Torr or lower during each measurement. All binding energies (BEs) were referenced to the C 1s hydrocarbon peak at 284.6 eV. In curve fitting, the line width (full width at half-maximum, or FWHM) for the Gaussian peaks was maintained constant for all components in a particular spectrum. The elemental sensitivity factors were calibrated using stable binary compounds of well-established stoichiometries. Each ion-etching operation unveiled a brand-new surface and the XPS spectra provided the means of analyzing the composition of these surfaces.

Supporting Information: Supporting Information is available from the Wiley

Online Library or from the author.

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References: [The reference list is preserved exactly as provided in the original text.]

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